

PLATAMID®

HX 2667 POWDER

Platamid® HX 2667 Powder
Copolyamide Hot Melt Adhesive / Textile Applications

Platamid® HX 2667 Powder is a medium melt viscosity copolyamide adhesive powder for the production of fusible interlinings. Platamid® HX 2667 Powder offers excellent laundry resistance up to 60°C and an excellent resistance to all kind of steam treatment.

性能	干 / 已调节	单位	测试标准
流变性能			
熔体体积流动速度	30 / *	cm³/10min	ISO 1133
温度	160 / *	°C	-
	320 / *	°F	-
载荷	2.16 / *	kg	-
	4.76 / *	lb	-
热性能			
熔融温度, 10°C/min	128 / *	°C	ISO 11357-1/-3
其它性能			
%Bio-Based	60	-	ASTM D6866

AVAILABLE GRADES

This grade is available in different grain sizes:

- Platamid® HX 2667 PA80 (0-80 µm paste dot)
- Platamid® HX 2667 PTA 170/20 (0-170 µm power dot)
- Platamid® HX 2667 PTA 170 (80-170 µm double dot)

PACKAGING

- Platamid® HX 2667 PA80 and Platamid® HX 2667 PTA 170/20 are delivered in 20 kg sealed bags.
- Platamid® HX 2667 PTA 170 is delivered in 20 kg sealed bags.

SHELF LIFE

Two years from the date of delivery. For any use above this limit, please refer to our technical services.

RENEWABLE CARBON CONTENT

60% (calculated, ASTM D6866)

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加工方法	
Scattering, Paste, Double Dot	
供货形式	
粉料	
特殊性能	
Adhesive, 生物基	
地区供应	
北美, 欧洲, 亚太, 中南美洲, 中东/非洲	